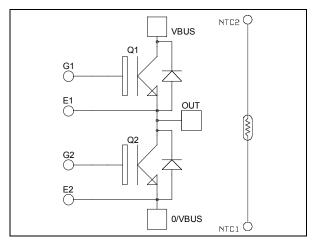
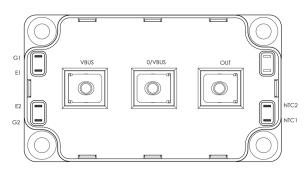


Phase leg High speed Trench + Field Stop IGBT4 Power module







Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

Features

- High speed Trench + Field Stop IGBT 4 Technology
 - Low voltage drop
 - Low leakage current
 - Low switching losses
 - Soft recovery parallel diodes
 - Low diode VF
 - RBSOA and SCSOA rated
- Kelvin source for easy drive
- Very low stray inductance
- M5 power connectors
- High level of integration
- Internal thermistor for temperature monitoring

Benefits

- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCEsat
- Low profile
- RoHS Compliant

All ratings @ $T_i = 25^{\circ}C$ unless otherwise specified

Absolute maximum ratings (per IGBT)

| Symbol | Parameter | | Max ratings | Unit |
|-------------|----------------------------------|----------------------|--------------|------|
| V_{CES} | Collector - Emitter Voltage | | 650 | V |
| T | Continuous Collector Current | $T_C = 25^{\circ}C$ | 770* | |
| $I_{\rm C}$ | Continuous Conector Current | $T_C = 60$ °C | 600* | A |
| I_{CM} | Pulsed Collector Current | $T_C = 25^{\circ}C$ | 1500 | |
| V_{GE} | Gate – Emitter Voltage | | ±20 | V |
| P_{D} | Maximum Power Dissipation | $T_C = 25^{\circ}C$ | 2000 | W |
| RBSOA | Reverse Bias Safe Operating Area | $T_j = 125^{\circ}C$ | 1200A @ 600V | |

^{*} Specification of device but current must be limited due to size of power connectors.

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

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Electrical Characteristics (per IGBT)

| | Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|---|----------------------|--------------------------------------|---|--|-----|------|-----|------|
| | I_{CES} | Zero Gate Voltage Collector Current | $V_{GE} = 0V, V_{CE} = 650V$ | | | | 600 | μΑ |
| Ī | V _{CE(sat)} | Collector Emitter saturation Voltage | $ \begin{array}{c c} V_{GE} = 15V & T_j = 25^{\circ}C \\ I_C = 600A & T_j = 150^{\circ}C \\ \end{array} $ | | | 1.85 | 2.3 | V |
| | | | | | | 2.2 | | v |
| | $V_{GE(th)}$ | Gate Threshold Voltage | $V_{GE} = V_{CE}$, $I_C = 3.2 \text{ mA}$ | | 4.2 | 5.1 | 5.6 | V |
| I | I_{GES} | Gate – Emitter Leakage Current | $V_{GE} = 20V, V_{CE} = 0V$ | | | | 1 | μA |

Dynamic Characteristics (per IGBT)

| · | Characteristic | Test Conditions | Min | Typ | Max | Unit | |
|------------------|-------------------------------------|---|--|-----|------|-------|------|
| Cies | Input Capacitance | $V_{GE} = 0V$ $V_{CE} = 25V$ | | | 36.6 | | |
| C_{oes} | Output Capacitance | | | | 1.3 | | nF |
| C_{res} | Reverse Transfer Capacitance | f = 1MHz | | | 1.08 | | |
| Q_{G} | Gate charge | $V_{GE} = 15V ; V_{CE} = 480V$ $I_{C} = 600A$ | | | 3500 | | nC |
| $T_{d(on)}$ | Turn-on Delay Time | Inductive Switc | | 19 | | | |
| T_{r} | Rise Time | $V_{GE} = \pm 15V$ | | | 33 | | |
| $T_{d(off)}$ | Turn-off Delay Time | $ \begin{array}{l} $ | | | 197 | | ns |
| $T_{\rm f}$ | Fall Time | | | | 21 | | |
| $T_{d(on)}$ | Turn-on Delay Time | Inductive Switching (150°C) $V_{GE} = \pm 15V$ $V_{CE} = 400V$ | | | 19 | | ns |
| $T_{\rm r}$ | Rise Time | | | | 29 | | |
| $T_{d(off)}$ | Turn-off Delay Time | $I_{\rm C} = 600 {\rm A}$ | | | 227 | | |
| $T_{\mathbf{f}}$ | Fall Time | $R_G = 0.6\Omega$ | | | 22 | | |
| Eon | Turn-on Switching Energy | $V_{GE} = \pm 15V$ | $T_J = 25^{\circ}C$ | | 12 | | mJ |
| | | $V_{CE} = 400V$ $I_{C} = 600A$ | $T_{J} = 150^{\circ}C$ $T_{J} = 25^{\circ}C$ | | 14.7 | | |
| E_{off} | Turn-off Switching Energy | $R_G = 0.6\Omega$ $T_J = 150^{\circ}C$ | | | 12 | | mJ |
| I_{sc} | Short Circuit data | $V_{GE} \le 15V ; V_{Bus} = 600V$ $t_p \le 10\mu s ; T_j = 150^{\circ}C$ | | | 3900 | | A |
| R_{thJC} | Junction to Case Thermal Resistance | | | | | 0.075 | °C/W |

Diode ratings and characteristics (per diode)

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit | | |
|-------------------|-------------------------------------|----------------------------|------------------------|--|----------------------------------|------|------|----|----|
| V_{RRM} | Repetitive Reverse Voltage | | | | | 650 | V | | |
| I_{RM} | Reverse Leakage Current | $V_R = 650V$ | | | | 300 | μΑ | | |
| I_F | DC Forward Current | | $T_c = 25^{\circ}C$ | | 600 | | A | | |
| V | Diode Forward Voltage | $I_F = 600A$ $V_{GE} = 0V$ | $T_j = 25$ °C | | 1.6 | 2 | V | | |
| V_{F} | | | $T_{j} = 150^{\circ}C$ | | 1.5 | | V | | |
| _ | , D. D. T. | $T_j = 25^{\circ}C$ | | 125 | | | | | |
| t_{rr} | Reverse Recovery Time | | I (00 A | $T_j = 15$ | $T_{\rm j} = 150^{\circ}{\rm C}$ | | 220 | | ns |
| 0 | Payarsa Pagayary Charga | $I_F = 600A$ $V_R = 400V$ | $T_j = 25$ °C | | 28.1 | | пС | | |
| Q_{rr} | Reverse Recovery Charge | 10 | | $di/dt = 7000A/\mu s$ $T_j = 150^{\circ}C$ | | 59.3 | | μC | |
| $\mathrm{E_{r}}$ | Reverse Recovery Energy | $T_j = 25^{\circ}C$ | $T_j = 25^{\circ}C$ | | 6.6 | | mJ | | |
| Ľŗ | Reverse Recovery Energy | | $T_{j} = 150^{\circ}C$ | | 14.4 | | 1113 | | |
| R_{thJC} | Junction to Case Thermal Resistance | | | | | 0.13 | °C/W | | |



Temperature sensor NTC (see application note APT0406 on www.microsemi.com).

| Symbol | Characteristic | | Min | Тур | Max | Unit |
|------------------------|-----------------------------|-----------------------|-----|------|-----|------|
| R ₂₅ | Resistance @ 25°C | ance @ 25°C | | 50 | | kΩ |
| $\Delta R_{25}/R_{25}$ | | | | 5 | | % |
| $B_{25/85}$ | $T_{25} = 298.15 \text{ K}$ | | | 3952 | | K |
| $\Delta B/B$ | | T _C =100°C | | 4 | | % |

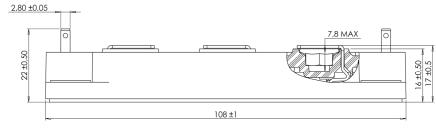
$$R_T = \frac{R_{25}}{\exp \left[B_{25/85} \left(\frac{1}{T_{25}} - \frac{1}{T} \right) \right]} \quad \text{T: Thermistor temperature}$$

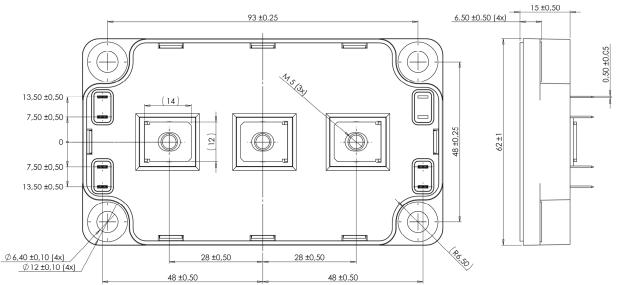
$$R_T: \text{ Thermistor value at T}$$

Thermal and package characteristics

| Symbol | Characteristic | | | Min | Max | Unit |
|-------------|--|---|-----|------|-----|--------|
| V_{ISOL} | RMS Isolation Voltage, any terminal to case t = 1 min, 50/60Hz | | | 4000 | | V |
| T_{J} | Operating junction temperature range | | | | 175 | |
| T_{JOP} | Recommended junction temperature und | Recommended junction temperature under switching conditions -40 T ₁ max -2 | | | | |
| T_{STG} | Storage Temperature Range | | | | 125 | °C |
| $T_{\rm C}$ | Operating Case Temperature | -40 | 100 | Ì | | |
| Torque | Manuting toward | To Heatsink | M6 | 3 | 5 | N.m |
| | Mounting torque | For teminals | M5 | 2 | 3.5 | IN.III |
| Wt | Package Weight | | | | 300 | g |

SP6 Package outline (dimensions in mm)

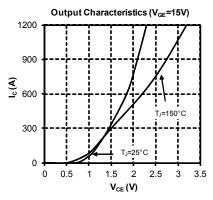


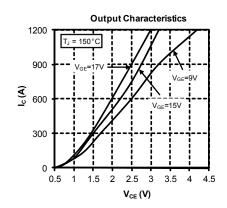


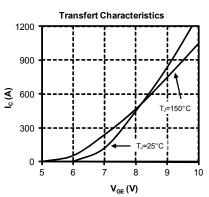
See application note APT0601 - Mounting Instructions for SP6 Power Modules on www.microsemi.com

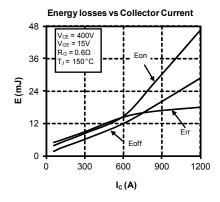


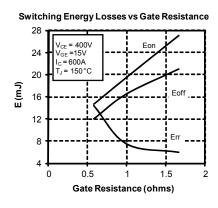
Typical Performance Curve

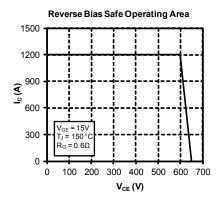


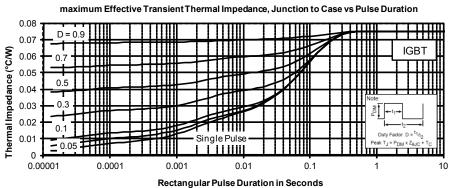






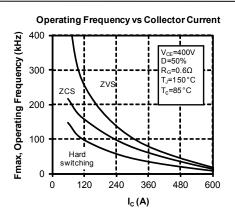


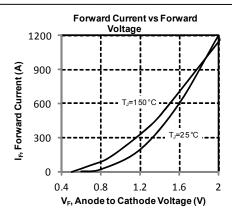




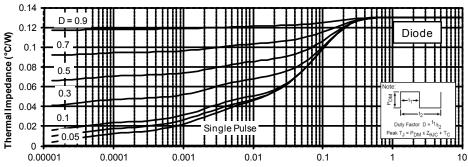
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Rectangular Pulse Duration in Seconds

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